

SF300R12E6



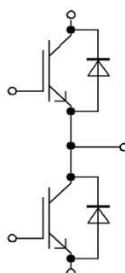
62mm module with IGBT and Diode

Features:

- 1200V Trench & Field stop technology
- Low switching losses
- Positive temperature coefficient

Applications:

- Motor Drives
- UPS
- High Frequency Switching Application



$V_{CES} = 1200V$, $I_{C\ nom} = 300A$ / $I_{CRM} = 600A$

IGBT, Inverter

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Collector-Emitter voltage	$T_{vj}=25^{\circ}C$	V_{CES}	1200	V
Continuous DC collector current	$T_C=100^{\circ}C$, $T_{vj\ max}=175^{\circ}C$	$I_{C\ nom}$	300	A
Repetitive peak collector current	$t_p=1\ ms$	I_{CRM}	600	A
Total power dissipation	$T_C = 25^{\circ}C$, $T_{vj\ max} = 175^{\circ}C$	P_{tot}	1500	W
Gate emitter voltage		V_{GE}	± 20	V

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	$V_{GE}=15V$, $I_C=300A$ $T_{vj}=25^{\circ}C$	V_{CEsat}		2.01		V
	$V_{GE}=15V$, $I_C=300A$ $T_{vj}=125^{\circ}C$			2.46		
	$V_{GE}=15V$, $I_C=300A$ $T_{vj}=150^{\circ}C$			2.58		
Gate-Emitter threshold voltage	$I_C=11.5mA$, $V_{GE}=V_{CE}$ $T_{vj}=25^{\circ}C$	$V_{GE(th)}$	5.3	5.90	6.4	
Gate charge	$V_{GE}=-15V \dots +15V$	Q_G		1.6		μC
Internal gate resistor		R_{Gint}		1.66		Ω
Input capacitance	$f=1\ MHz$, $V_{CE}=25\ V$, $V_{GE}=0\ V$ $T_{vj}=25^{\circ}C$	C_{ies}		27.53		nF
Output capacitance		C_{oes}		1.90		
Reverse transfer capacitance		C_{res}		0.83		nF

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Collector-emitter cut-off current	$V_{CE}=1200V$, $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	I_{CES}			1	mA
Gate-emitter leakage current	$V_{CE}=0V$, $V_{GE}=20V$	$T_{vj}=25^{\circ}C$	I_{GES}			100	nA
Turn-on delay time	$I_C=300A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=1.8\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_{d\ on}$		150 180 185		
Rise time	$I_C=300A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=1.8\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	t_r		45 50 52		
Turn-off delay time	$I_C=300A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=1.8\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	$t_{d\ off}$		280 340 350		ns
Fall time	$I_C=300A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=1.8\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	t_f		190 250 270		
Turn-on energy loss per pulse	$I_C=300A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=1.8\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	E_{on}		12.0 25.8 30.2		
Turn-off energy loss per pulse	$I_C=300A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=1.8\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	E_{off}		24.0 33.3 35.8		mJ
SC data	$V_{GE}\leq 15V$, $V_{ce}=800V$ $V_{CEmax}=V_{CES}-L_{sCE}\cdot di/dt$ $t_p\leq 10\mu s$, $T_{vj}=150^{\circ}C$		I_{sc}		927		A
Thermal resistance, junction to case	per IGBT		R_{thJC}			0.1	K/W
Temperature under switching conditions			$T_{vj\ op}$	-40		150	$^{\circ}C$

Diode, Inverter

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Repetitive peak reverse voltage	$T_{vj}=25^{\circ}C$	V_{RRM}	1200	V
Continuous DC forward current		I_F	300	A
Repetitive peak forward current	$t_p=1ms$	I_{FRM}	600	A

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F=300A$, $V_{GE}=0V$ $I_F=300A$, $V_{GE}=0V$ $I_F=300A$, $V_{GE}=0V$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	V_F	2.26 2.35 2.25		V
Peak reverse recovery current	$I_F=300A$, - $di_F/dt=4870A/\mu s$ ($T_{vj}=150^{\circ}C$) $V_R=600V$, $V_{GE}=-15V$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	I_{RM}	215 239 256		A

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Recovered charge	$I_F=300A$, $-di_F/dt=4870A/\mu s(T_{vj}=150^{\circ}C)$ $V_R=600V, V_{GE}=-15V$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	Q_r		15.4 36.4 47.6		μC
Reverse recovered energy	$I_F=300A$, $-di_F/dt=4870A/\mu s(T_{vj}=150^{\circ}C)$ $V_R=600V, V_{GE}=-15V$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	E_{rec}		6.8 14.9 19.3		mJ
Thermal resistance, junction to case	Per diode		R_{thjc}			0.15	K/W

Module

Isolation test voltage	RMS, $f = 50Hz$, $t = 1min$	V_{ISOL}	4	kV
Material module baseplate			Cu	
Mounting torque for modul mounting	to heat sink M6	M	3~6	Nm
Terminal connection torque	to terminals M6	M	2.5~5	Nm

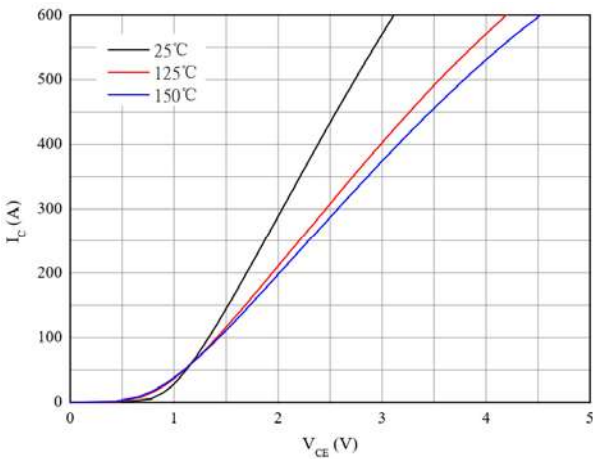


Figure 1. Typical output characteristics ($V_{GE}=15V$)

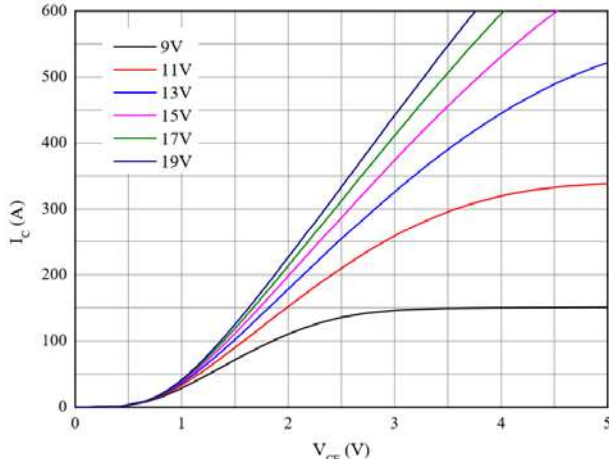
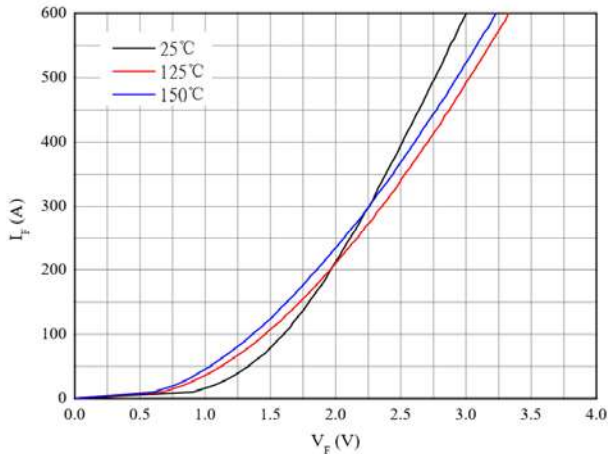
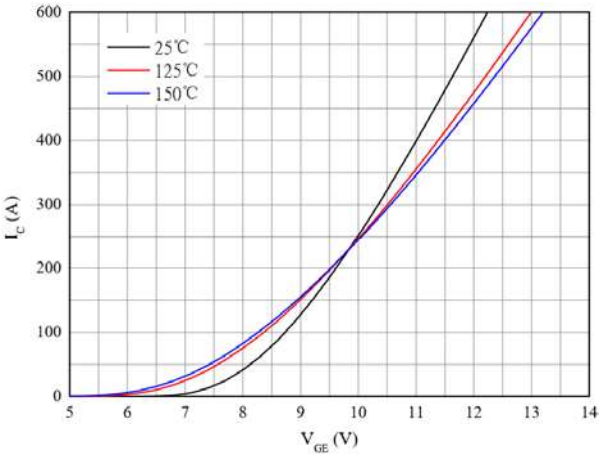


Figure 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)



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Figure 3. Typical transfer characteristic($V_{CE}=20V$)

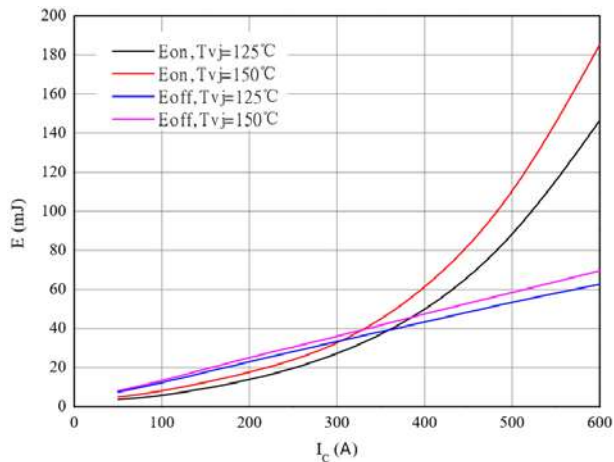


Figure 5. Switching losses of IGBT
 $V_{GE}=\pm 15V$, $R_{Gon}=1.8\Omega$, $R_{Goff}=1.8\Omega$, $V_{CE}=600V$

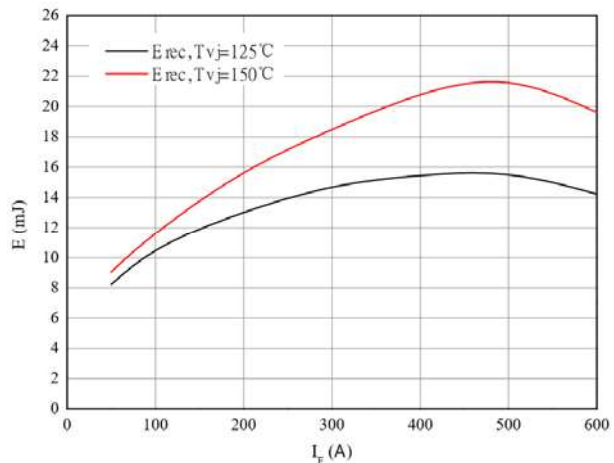


Figure 7. Switching losses of Diode
 $R_{Gon}=1.8\Omega$, $V_{CE}=600V$

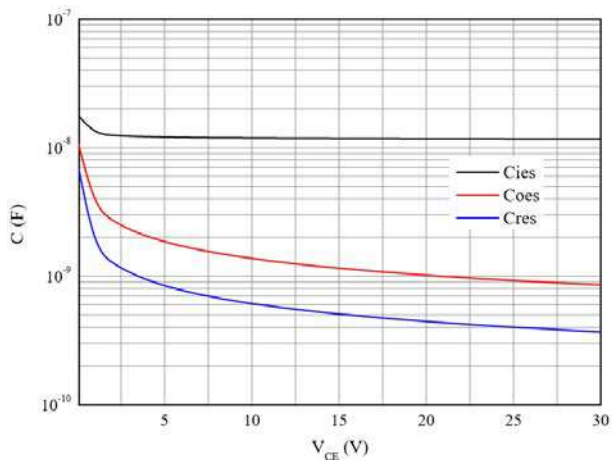


Figure 4. Forward characteristic of Diode

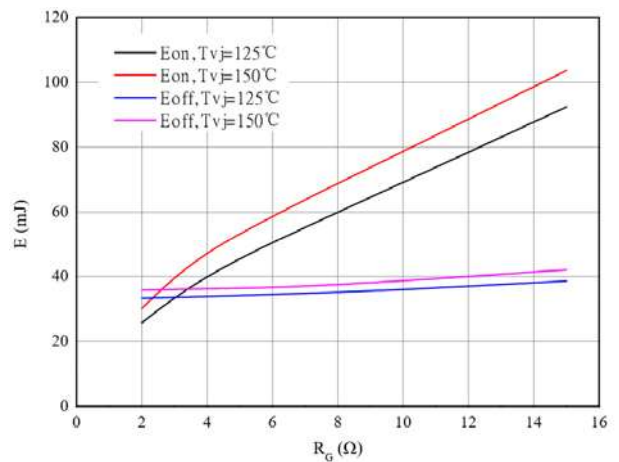


Figure 6. Switching losses of IGBT
 $V_{GE}=\pm 15V$, $I_c=300A$, $V_{CE}=600V$

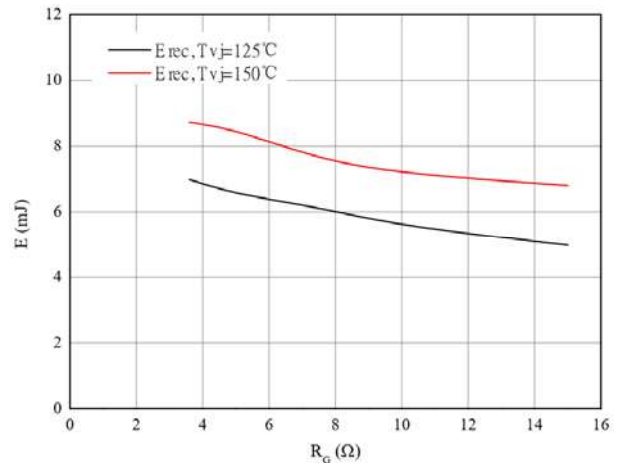


Figure 8. Switching losses of Diode
 $I_F=300A$, $V_{CE}=600V$

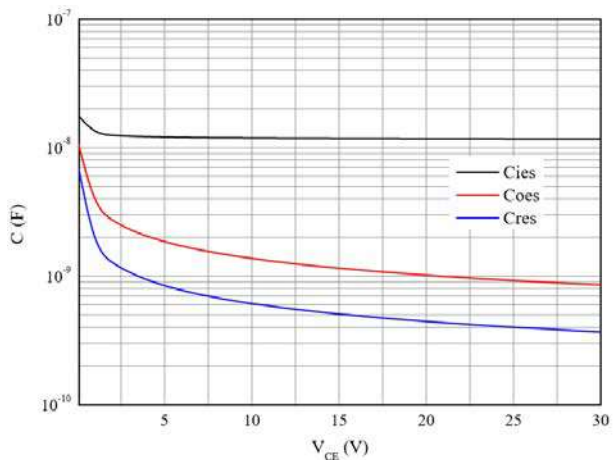
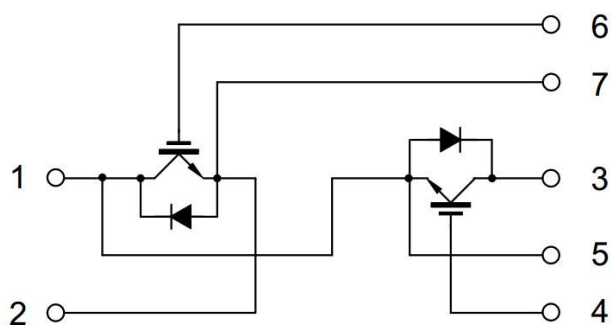


Figure 9. Capacitance characteristic



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Circuit diagram



Package outlines

